

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																		
NATURE OF CONVEYANCE:	ASSIGNMENT																		
CONVEYING PARTY DATA																			
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr><td>Yusuke SEKI</td><td>07/12/2005</td></tr> <tr><td>Mitsuru ONUMA</td><td>07/12/2005</td></tr> <tr><td>Akihiko KANDORI</td><td>07/25/2005</td></tr> <tr><td>Daisuke SUZUKI</td><td>07/12/2005</td></tr> <tr><td>Takuya AKASHI</td><td>07/12/2005</td></tr> <tr><td>Masahiro MURAKAMI</td><td>07/14/2005</td></tr> <tr><td>Atsushi WATANABE</td><td>07/13/2005</td></tr> <tr><td>Yoshio MATSUOKA</td><td>07/13/2005</td></tr> </tbody> </table>		Name	Execution Date	Yusuke SEKI	07/12/2005	Mitsuru ONUMA	07/12/2005	Akihiko KANDORI	07/25/2005	Daisuke SUZUKI	07/12/2005	Takuya AKASHI	07/12/2005	Masahiro MURAKAMI	07/14/2005	Atsushi WATANABE	07/13/2005	Yoshio MATSUOKA	07/13/2005
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RECEIVING PARTY DATA																			
Name:	HITACHI HIGH-TECHNOLOGIES CORPORATION																		
Street Address:	24-14, Nishishinbashi 1-chome, Minato-ku																		
City:	Tokyo																		
State/Country:	JAPAN																		
PROPERTY NUMBERS Total: 1																			
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11196750</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11196750														
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CORRESPONDENCE DATA																			
Fax Number:	(703)684-1157																		
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CH \$40.00 11196750

NAME OF SUBMITTER:

Daniel J. Stanger

Total Attachments: 1

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ASSIGNMENT
(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 24-14, Nishishinbashi 1-chome, Minato-ku, Tokyo, Japan receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

MAGNETIC SHIELDING APPARATUS AND BIOMAGNETISM MEASURING DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) <u>Yusuke Seki</u>	<u>7/12/2005</u>
2) <u>Mitsuru Onuma</u>	<u>7/12/2005</u>
3) <u>Akitake Kandori</u>	<u>7/25/2005</u>
4) <u>Daisuke Suzuki</u>	<u>7/12/2005</u>
5) <u>Takuya Banuchi</u>	<u>7/12/2005</u>
6) <u>Masahiro Murakami</u>	<u>7/14/2005</u>
7) <u>Atsushi Watanabe</u>	<u>7/13/2005</u>
8) <u>Yoshio Matsuoka</u>	<u>7/13/2005</u>
9) _____	_____
10) _____	_____